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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	80 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16lc554-04e-p">https://www.e-xfl.com/product-detail/microchip-technology/pic16lc554-04e-p</a>

# PIC16C55X

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NOTES:

## 4.2.2.3 INTCON Register

The INTCON register is a readable and writable register which contains the various enable and flag bits for all interrupt sources.

**Note:** Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

### REGISTER 4-3: INTCON REGISTER (ADDRESS 0BH OR 8BH)

R/W-0	Reserved	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE	—	TOIE	INTE	RBIE	TOIF	INTF	RBIF
bit7							bit0

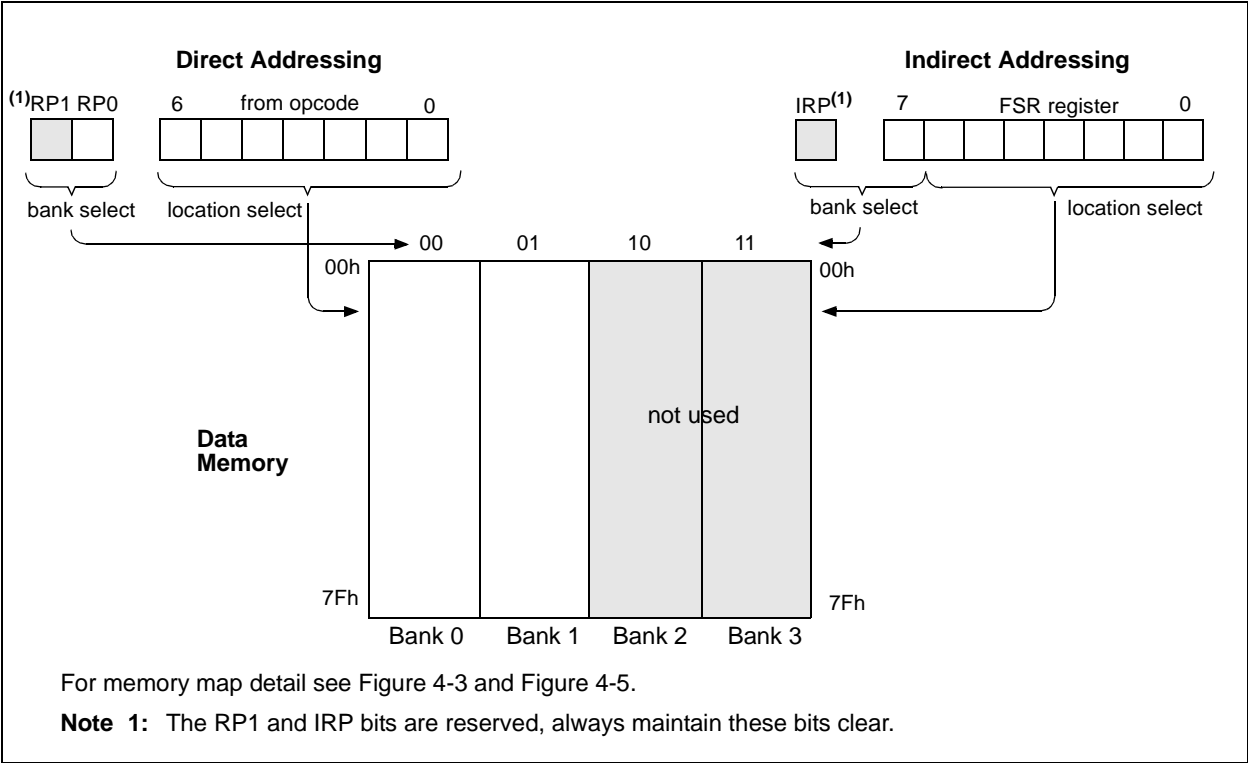
- bit 7 **GIE:** Global Interrupt Enable bit  
1 = Enables all un-masked interrupts  
0 = Disables all interrupts
- bit 6 **Reserved:** For future use. Always maintain this bit clear.
- bit 5 **TOIE:** TMR0 Overflow Interrupt Enable bit  
1 = Enables the TMR0 interrupt  
0 = Disables the TMR0 interrupt
- bit 4 **INTE:** RB0/INT External Interrupt Enable bit  
1 = Enables the RB0/INT external interrupt  
0 = Disables the RB0/INT external interrupt
- bit 3 **RBIE:** RB Port Change Interrupt Enable bit  
1 = Enables the RB port change interrupt  
0 = Disables the RB port change interrupt
- bit 2 **TOIF:** TMR0 Overflow Interrupt Flag bit  
1 = TMR0 register has overflowed (must be cleared in software)  
0 = TMR0 register did not overflow
- bit 1 **INTF:** RB0/INT External Interrupt Flag bit  
1 = The RB0/INT external interrupt occurred (must be cleared in software)  
0 = The RB0/INT external interrupt did not occur
- bit 0 **RBIF:** RB Port Change Interrupt Flag bit  
1 = When at least one of the RB7:RB4 pins changed state (must be cleared in software)  
0 = None of the RB7:RB4 pins have changed state

**Legend:**

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
- n = Value at POR reset	'1' = Bit is set	'0' = Bit is cleared      x = Bit is unknown

# PIC16C55X

FIGURE 4-7: DIRECT/INDIRECT ADDRESSING PIC16C55X



## 5.4 I/O Programming Considerations

### 5.4.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The `BCF` and `BSF` instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a `BSF` operation on bit5 of `PORTB` will cause all eight bits of `PORTB` to be read into the CPU. Then the `BSF` operation takes place on bit5 and `PORTB` is written to the output latches. If another bit of `PORTB` is used as a bi-directional I/O pin (e.g., bit 0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the Input mode, no problem occurs. However, if bit 0 is switched into Output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. `BCF`, `BSF`, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-1 shows the effect of two sequential read-modify-write instructions (ex., `BCF`, `BSF`, etc.) on an I/O port.

A pin actively outputting a low or high should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

## 6.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC16C55X family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection.

These are:

1. OSC selection
2. RESET
3. Power-on Reset (POR)
4. Power-up Timer (PWRT)
5. Oscillator Start-Up Timer (OST)
6. Interrupts
7. Watchdog Timer (WDT)
8. SLEEP
9. Code protection
10. ID Locations
11. In-circuit serial programming™

The PIC16C55X has a Watchdog Timer which is controlled by configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), which is intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in RESET while the power supply stabilizes. With these two functions on-chip, most applications need no external RESET circuitry.

The SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

## 6.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h – 3FFFh), which can be accessed only during programming.

## 6.2 Oscillator Configurations

### 6.2.1 OSCILLATOR TYPES

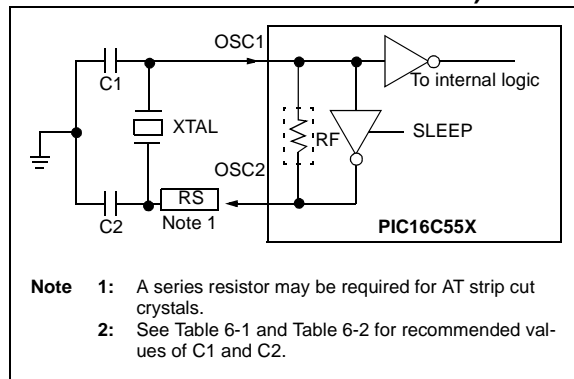
The PIC16C55X can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

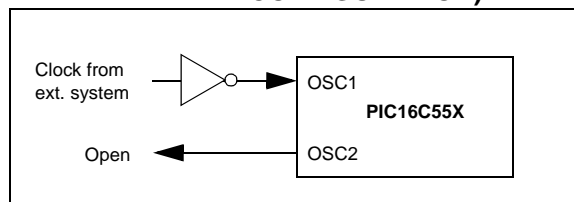
### 6.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 6-1). The PIC16C55X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin (Figure 6-2).

**FIGURE 6-1: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)**



**FIGURE 6-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)**



**TABLE 6-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS (PRELIMINARY)**

Ranges Characterized:			
Mode	Freq	OSC1(C1)	OSC2(C2)
XT	455 kHz	22 - 100 pF	22 - 100 pF
	2.0 MHz	15 - 68 pF	15 - 68 pF
	4.0 MHz	15 - 68 pF	15 - 68 pF
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF

**Note 1:** Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult with the resonator manufacturer for appropriate values of external components.

**TABLE 6-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR (PRELIMINARY)**

Mode	Freq	OSC1(C1)	OSC2(C2)
LP	32 kHz	68 - 100 pF	68 - 100 pF
	200 kHz	15 - 30 pF	15 - 30 pF
XT	100 kHz	68 - 150 pF	150 - 200 pF
	2 MHz	15 - 30 pF	15 - 30 pF
	4 MHz	15 - 30 pF	15 - 30 pF
HS	8 MHz	15 - 30 pF	15 - 30 pF
	10 MHz	15 - 30 pF	15 - 30 pF
	20 MHz	15 - 30 pF	15 - 30 pF

**Note 1:** Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid over-driving crystals with low-drive level specification. Since each crystal has its own characteristics, the user should consult with the crystal manufacturer for appropriate values of external components.

# PIC16C55X

FIGURE 7-3:       TIMER0 TIMING: INTERNAL CLOCK/PRESCALE 1:2

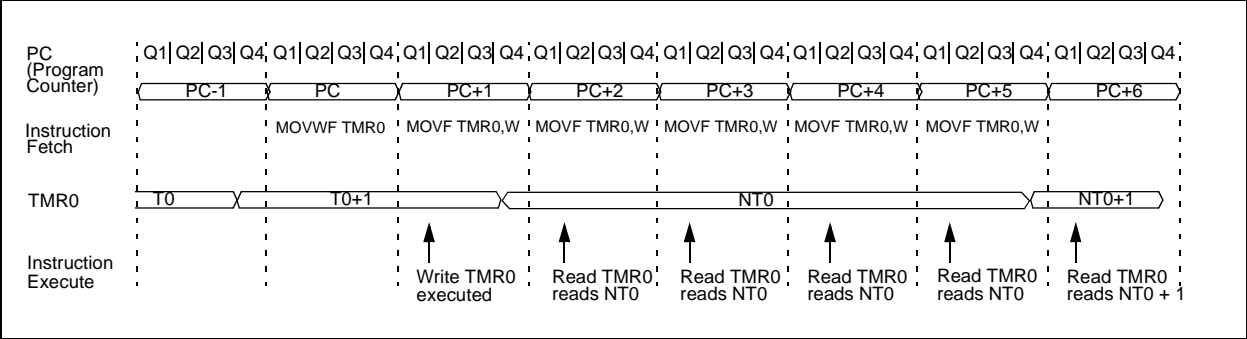
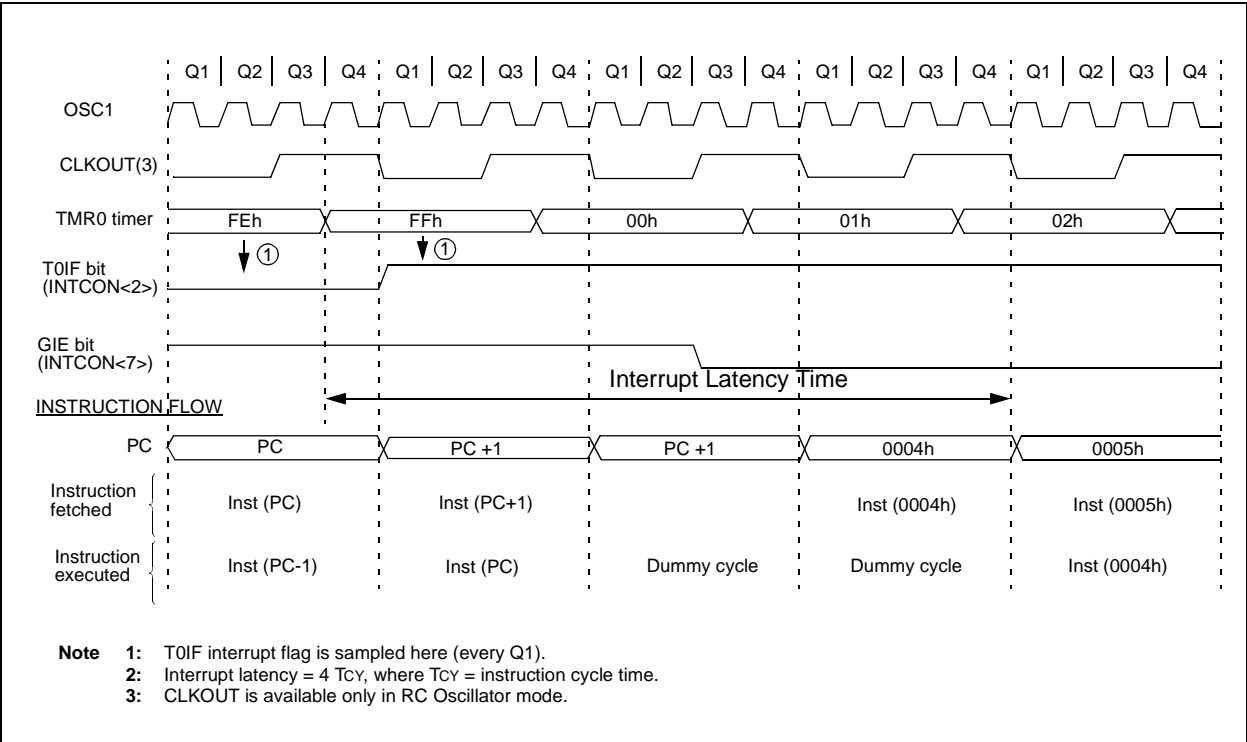


FIGURE 7-4:       TIMER0 INTERRUPT TIMING





## 8.0 INSTRUCTION SET SUMMARY

Each PIC16C55X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C55X instruction set summary in Table 8-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 8-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

**TABLE 8-1: OPCODE FIELD DESCRIPTIONS**

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Timeout bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[ ]	Options
( )	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
<i>italics</i>	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs.

Table 8-1 lists the instructions recognized by the MPASM™ assembler.

Figure 8-1 shows the three general formats that the instructions can have.

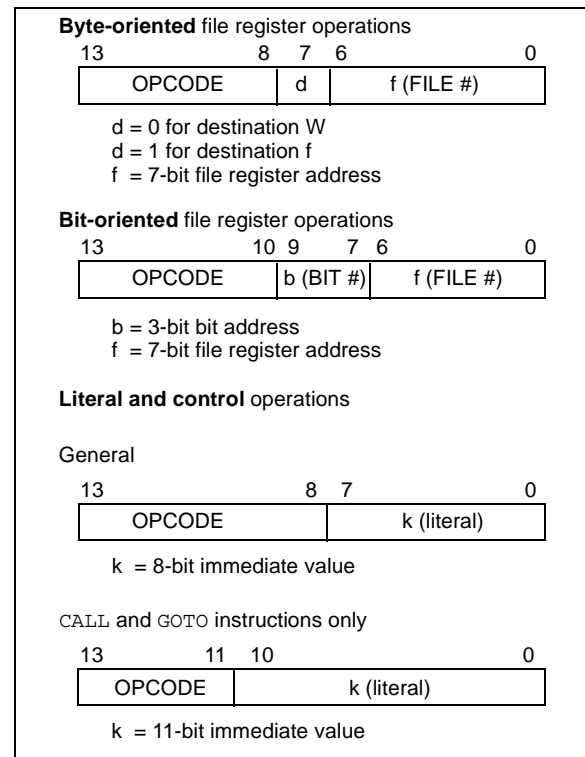
**Note:** To maintain upward compatibility with future PIC® MCU products, do not use the `OPTION` and `TRIS` instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

**FIGURE 8-1: GENERAL FORMAT FOR INSTRUCTIONS**



# PIC16C55X

## BCF Bit Clear f

Syntax:	[ <i>label</i> ] BCF f,b				
Operands:	$0 \leq f \leq 127$ $0 \leq b \leq 7$				
Operation:	$0 \rightarrow (f<b>)$				
Status Affected:	None				
Encoding:	<table border="1"><tr><td>01</td><td>00bb</td><td>bfff</td><td>ffff</td></tr></table>	01	00bb	bfff	ffff
01	00bb	bfff	ffff		
Description:	Bit 'b' in register 'f' is cleared.				
Words:	1				
Cycles:	1				
Example	BCF FLAG_REG, 7				

Before Instruction  
FLAG\_REG = 0xC7  
After Instruction  
FLAG\_REG = 0x47

## BSF Bit Set f

Syntax:	[ <i>label</i> ] BSF f,b			
Operands:	$0 \leq f \leq 127$ $0 \leq b \leq 7$			
Operation:	$1 \rightarrow (f<b>)$			
Status Affected:	None			
Encoding:	01	01bb	bfff	ffff
Description:	Bit 'b' in register 'f' is set.			
Words:	1			
Cycles:	1			
Example	BSF	FLAG_REG,	7	

Before Instruction  
FLAG\_REG = 0x0A  
After Instruction  
FLAG\_REG = 0x8A

## BTFSC Bit Test, Skip if Clear

Syntax:	[ <i>label</i> ] BTFSC f,b			
Operands:	$0 \leq f \leq 127$ $0 \leq b \leq 7$			
Operation:	skip if (f<b>) = 0			
Status Affected:	None			
Encoding:	01	10bb	bfff	ffff
Description:	If bit 'b' in register 'f' is '0' then the next instruction is skipped. If bit 'b' is '0' then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a two-cycle instruction.			

Words: 1  
Cycles: 1(2)  
Example

HERE	BTFSC	FLAG, 1
FALSE	GOTO	PROCESS_CODE
TRUE	.	
	.	
	.	

Before Instruction  
PC = address HERE  
After Instruction  
if FLAG<1> = 0,  
PC = address TRUE  
if FLAG<1> = 1,  
PC = address FALSE

## DECFSZ Decrement f, Skip if 0

**Syntax:** `[label] DECFSZ f,d`

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**  $(f) - 1 \rightarrow (\text{dest}); \text{ skip if result} = 0$

**Status Affected:** None

**Encoding:**

00	1011	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two-cycle instruction.

**Words:** 1

**Cycles:** 1(2)

**Example**

```

HERE    DECFSZ  CNT, 1
        GOTO    LOOP
CONTINUE •
        •
        •

```

**Before Instruction**  
PC = address HERE

**After Instruction**  
CNT = CNT - 1  
if CNT = 0,  
PC = address CONTINUE  
if CNT  $\neq$  0,  
PC = address HERE+1

## GOTO Unconditional Branch

**Syntax:** `[label] GOTO k`

**Operands:**  $0 \leq k \leq 2047$

**Operation:**  $k \rightarrow \text{PC}<10:0>$   
 $\text{PCLATH}<4:3> \rightarrow \text{PC}<12:11>$

**Status Affected:** None

**Encoding:**

10	1kkk	kkkk	kkkk
----	------	------	------

**Description:** GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.

**Words:** 1

**Cycles:** 2

**Example**

```

GOTO THERE

```

**After Instruction**  
PC = Address THERE

## INCF Increment f

**Syntax:** `[label] INCF f,d`

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**  $(f) + 1 \rightarrow (\text{dest})$

**Status Affected:** Z

**Encoding:**

00	1010	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

**Words:** 1

**Cycles:** 1

**Example**

```

INCF    CNT, 1

```

**Before Instruction**  
CNT = 0xFF  
Z = 0

**After Instruction**  
CNT = 0x00  
Z = 1

## RRF Rotate Right f through Carry

**Syntax:** [ *label* ] RRF *f*,*d*

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

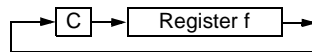
**Operation:** See description below

**Status Affected:** C

**Encoding:**

00	1100	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.



**Words:** 1

**Cycles:** 1

**Example** RRF REG1,0

**Before Instruction**

REG1 = 1110 0110  
C = 0

**After Instruction**

REG1 = 1110 0110  
W = 0111 0011  
C = 0

## SLEEP

**Syntax:** [ *label* ] SLEEP

**Operands:** None

**Operation:** 00h → WDT,  
0 → WDT prescaler,  
1 →  $\overline{TO}$ ,  
0 →  $\overline{PD}$

**Status Affected:**  $\overline{TO}$ ,  $\overline{PD}$

**Encoding:**

00	0000	0110	0011
----	------	------	------

**Description:** The power-down status bit,  $\overline{PD}$  is cleared. Timeout status bit,  $\overline{TO}$  is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See Section 6.8 for more details.

**Words:** 1

**Cycles:** 1

**Example:** SLEEP

## SUBLW Subtract W from Literal

**Syntax:** [ *label* ] SUBLW *k*

**Operands:**  $0 \leq k \leq 255$

**Operation:**  $k - (W) \rightarrow (W)$

**Status Affected:** C, DC, Z

**Encoding:**

11	110x	kkkk	kkkk
----	------	------	------

**Description:** The W register is subtracted (2's complement method) from the eight bit literal 'k'. The result is placed in the W register.

**Words:** 1

**Cycles:** 1

**Example 1:** SUBLW 0x02

**Before Instruction**

W = 1  
C = ?

**After Instruction**

W = 1  
C = 1; result is positive

**Example 2:**

**Before Instruction**

W = 2  
C = ?

**After Instruction**

W = 0  
C = 1; result is zero

**Example 3:**

**Before Instruction**

W = 3  
C = ?

**After Instruction**

W = 0xFF  
C = 0; result is negative

## **XORLW Exclusive OR Literal with W**

Syntax:	[ <i>label</i> ] XORLW <i>k</i>				
Operands:	$0 \leq k \leq 255$				
Operation:	(W) .XOR. <i>k</i> $\rightarrow$ (W)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>11</td><td>1010</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1010	kkkk	kkkk
11	1010	kkkk	kkkk		
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example:	<pre>XORLW    0xAF</pre> <p>Before Instruction</p> <p>W = 0xB5</p> <p>After Instruction</p> <p>W = 0x1A</p>				

## **XORWF Exclusive OR W with f**

Syntax:	[ <i>label</i> ] XORWF f,d				
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$				
Operation:	(W) .XOR. (f) $\rightarrow$ (dest)				
Status Affected:	Z				
Encoding:	<table border="1"><tr><td>00</td><td>0110</td><td>dfff</td><td>ffff</td></tr></table>	00	0110	dfff	ffff
00	0110	dfff	ffff		
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Example	<pre>XORWF    REG    1</pre> <p>Before Instruction</p> <p>REG = 0xAF W = 0xB5</p> <p>After Instruction</p> <p>REG = 0x1A W = 0xB5</p>				

# PIC16C55X

## 10.1 DC Characteristics: PIC16C55X-04 (Commercial, Industrial, Extended) PIC16C55X-20 (Commercial, Industrial, Extended) HCS1365-04 (Commercial, Industrial, Extended)

<b>DC Characteristics</b> <div> <b>Standard Operating Conditions (unless otherwise stated)</b>            Operating temperature <math>-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}</math> for industrial and  <math>0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}</math> for commercial and  <math>-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}</math> for extended         </div>							
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D001	V <sub>DD</sub>	<b>Supply Voltage</b>					
		16LC55X	3.0 2.5	—	5.5 5.5	V	XT and RC osc configuration LP osc configuration
D001 D001A		16C55X	3.0 4.5	— —	5.5 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002	V <sub>DR</sub>	<b>RAM Data Retention Voltage<sup>(1)</sup></b>	—	1.5*	—	V	Device in SLEEP mode
D003	V <sub>POR</sub>	<b>V<sub>DD</sub> Start Voltage</b> to ensure Power-on Reset	—	V <sub>SS</sub>	—	V	See Section 6.4, Power-on Reset for details
D004	S <sub>VDD</sub>	<b>V<sub>DD</sub> Rise Rate</b> to ensure Power-on Reset	0.05*	—	—	V/ms	See Section 6.4, Power-on Reset for details
D010 D010A D010 D010A D013	I <sub>DD</sub>	<b>Supply Current<sup>(2)</sup></b>					
		16LC55X	—	1.4	2.5	mA	XT and RC osc configuration Fosc = 2.0 MHz, V <sub>DD</sub> = 3.0V, WDT disabled <sup>(4)</sup>
			—	26	53	μA	LP osc configuration Fosc = 32 kHz, V <sub>DD</sub> = 3.0V, WDT disabled
		16C55X	—	1.8	3.3	mA	XT and RC osc configuration Fosc = 4 MHz, V <sub>DD</sub> = 5.5V, WDT disabled <sup>(4)</sup>
			—	35	70	μA	LP osc configuration, PIC16C55X-04 only Fosc = 32 kHz, V <sub>DD</sub> = 4.0V, WDT disabled
			—	9.0	20	mA	HS osc configuration Fosc = 20 MHz, V <sub>DD</sub> = 5.5V, WDT disabled

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which V<sub>DD</sub> can be lowered in SLEEP mode without losing RAM data.

**Note 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I<sub>DD</sub> measurements in active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins configured as input, pulled to V<sub>DD</sub>,

MCLR = V<sub>DD</sub>; WDT enabled/disabled as specified.

**Note 3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins configured as input and tied to V<sub>DD</sub> or V<sub>SS</sub>.

**Note 4:** For RC osc configuration, current through R<sub>EXT</sub> is not included. The current through the resistor can be estimated by the formula  $I_r = V_{DD}/2R_{EXT}$  (mA) with R<sub>EXT</sub> in kΩ.

**Note 5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I<sub>DD</sub> or I<sub>PD</sub> measurement.

# PIC16C55X

## 10.2 DC Characteristics: PIC16C55X (Commercial, Industrial, Extended) PIC16LC55X(Commercial, Industrial, Extended)

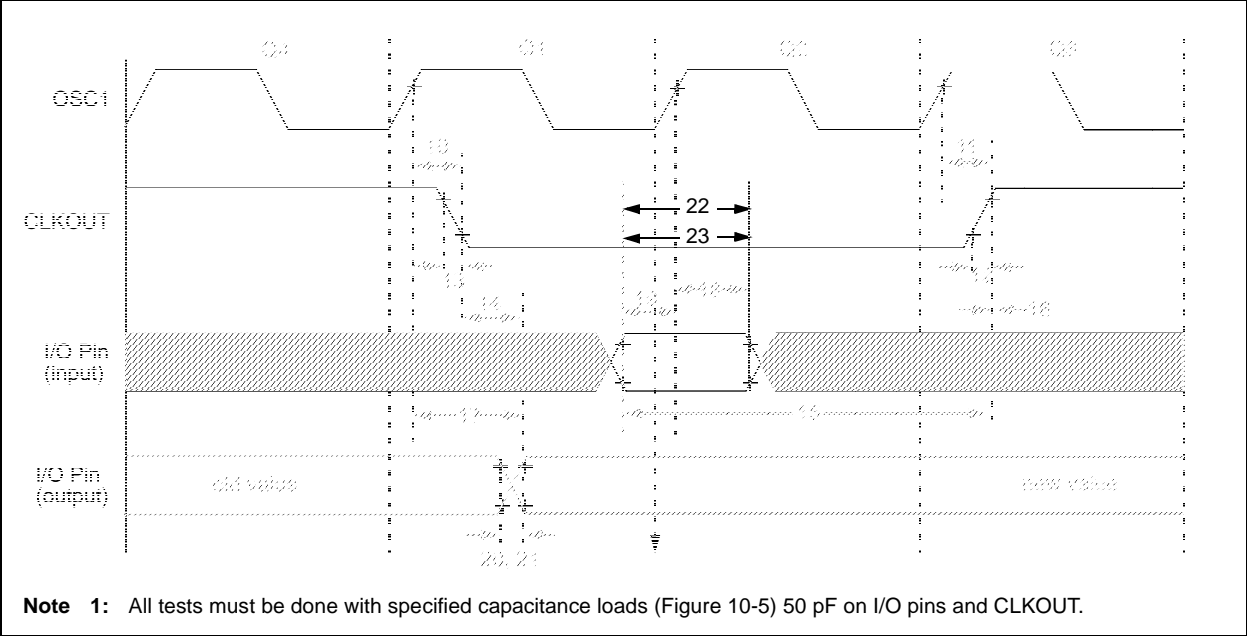
<b>Standard Operating Conditions (unless otherwise stated)</b> Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for automotive Operating voltage $V_{DD}$ range as described in DC spec Table 10-1							
<b>DC Characteristics</b>							
Param. No.	Sym	Characteristic	Min	Typ†	Max	Unit	Conditions
D030	V <sub>IL</sub>	<b>Input Low Voltage</b>					
		I/O ports					
		with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15 V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	V <sub>SS</sub>		0.2 V <sub>DD</sub>	V	
		MCLR, RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	(Note1)
D033		OSC1 (in XT* and HS)	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
		OSC1 (in LP*)	V <sub>SS</sub>	—	0.6 V <sub>DD</sub> -1.0	V	
D040	V <sub>IH</sub>	<b>Input High Voltage</b>					
		I/O ports					
		with TTL buffer	2.0V 0.8 + 0.25 V <sub>DD</sub>	—	V <sub>DD</sub> V <sub>DD</sub>	V V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	0.8V		V <sub>DD</sub>	V	
		MCLR RA4/T0CKI	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
		OSC1 (XT*, HS and LP*)	0.7 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
D043A		OSC1 (in RC mode)	0.9 V <sub>DD</sub>				(Note1)
D070	IPURB	PORTB weak pull-up current	50	200	400	μA	V <sub>DD</sub> = 5.0V, V <sub>PIN</sub> = V <sub>SS</sub>
D060	I <sub>IL</sub>	<b>Input Leakage Current<sup>(2)(3)</sup></b>					
		I/O ports (Except PORTA)			±1.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , pin at hi-impedance
		PORTA	—	—	±0.5	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , pin at hi-impedance
		RA4/T0CKI	—	—	±1.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub>
		OSC1, MCLR	—	—	±5.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , XT, HS and LP osc configuration
D080	V <sub>OL</sub>	<b>Output Low Voltage</b>					
		I/O ports	—	—	0.6	V	I <sub>OL</sub> =8.5 mA, V <sub>DD</sub> =4.5V, -40° to +85°C
			—	—	0.6	V	I <sub>OL</sub> =7.0 mA, V <sub>DD</sub> =4.5V, +125°C
		OSC2/CLKOUT	—	—	0.6	V	I <sub>OL</sub> =1.6 mA, V <sub>DD</sub> =4.5V, -40° to +85°C
		(RC only)	—	—	0.6	V	I <sub>OL</sub> =1.2 mA, V <sub>DD</sub> =4.5V, +125°C
D090	V <sub>OH</sub>	<b>Output High Voltage<sup>(3)</sup></b>					
		I/O ports (Except RA4)	V <sub>DD</sub> -0.7	—	—	V	I <sub>OH</sub> =-3.0 mA, V <sub>DD</sub> =4.5V, -40° to +85°C

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C55X be driven with external clock in RC mode.
- Note 2:** The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- Note 3:** Negative current is defined as coming out of the pin.

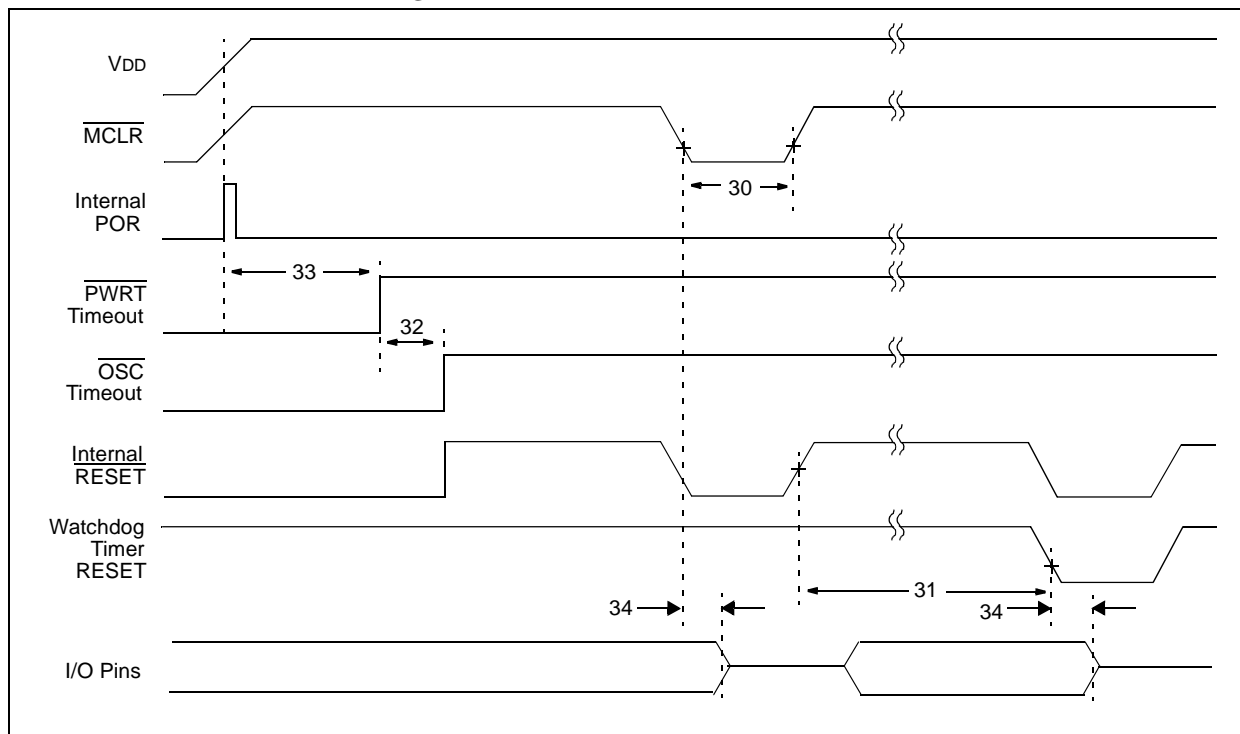
FIGURE 10-7: CLKOUT AND I/O TIMING





# PIC16C55X

**FIGURE 10-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING**



**TABLE 10-3: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS**

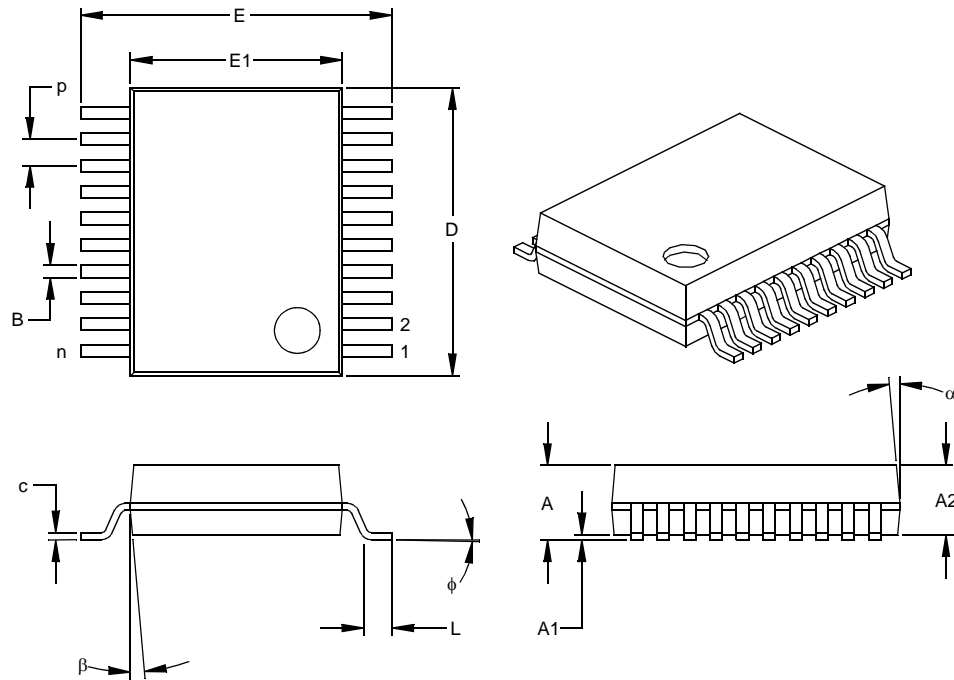
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2000	—	—	ns	-40° to +85°C
31	Twdt	Watchdog Timer Timeout Period (No Prescaler)	7*	18	33*	ms	VDD = 5.0V, -40° to +85°C
32	Tost	Oscillation Start-up Timer Period	—	1024 TOSC	—	—	TOSC = OSC1 period
33	Tpwrt	Power-up Timer Period	28*	72	132*	ms	VDD = 5.0V, -40° to +85°C
34	Tioz	I/O hi-impedance from MCLR low	—	—	2.0*	μs	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## 20-Lead Plastic Shrink Small Outline (SS) – 209 mil, 5.30 mm (SSOP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		20			20	
Pitch	p		.026			0.65	
Overall Height	A	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	E	.299	.309	.322	7.59	7.85	8.18
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.278	.284	.289	7.06	7.20	7.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	c	.004	.007	.010	0.10	0.18	0.25
Foot Angle	φ	0	4	8	0.00	101.60	203.20
Lead Width	B	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

\* Controlling Parameter

§ Significant Characteristic

**Notes:**

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

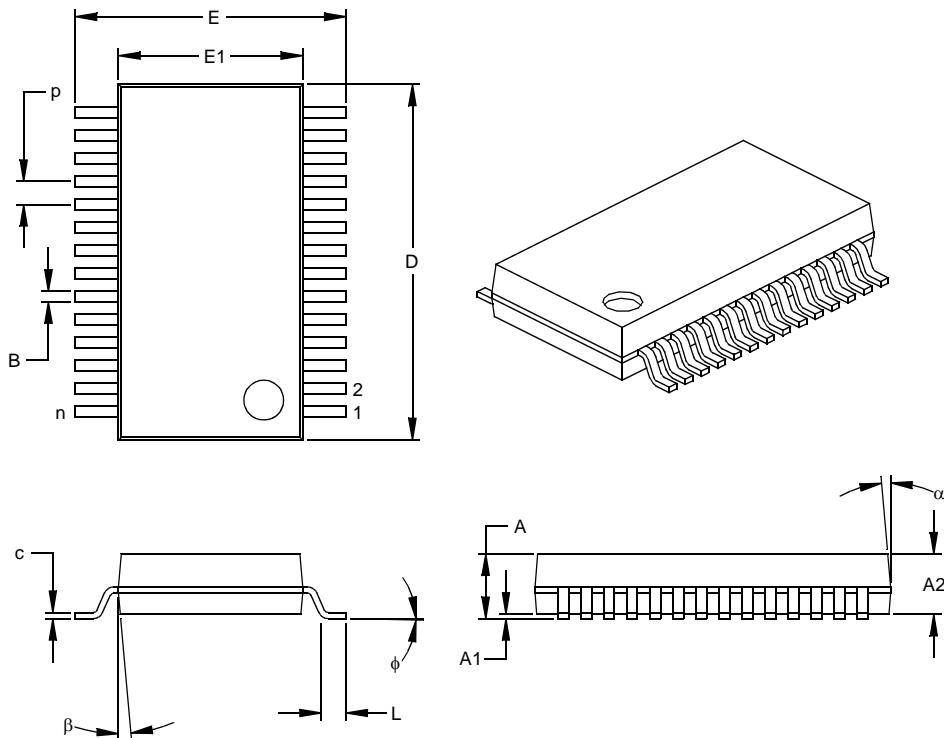
JEDEC Equivalent: MO-150

Drawing No. C04-072

# PIC16C55X

## 28-Lead Plastic Shrink Small Outline (SS) – 209 mil, 5.30 mm (SSOP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	p		.026			0.65	
Overall Height	A	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	E	.299	.309	.319	7.59	7.85	8.10
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.396	.402	.407	10.06	10.20	10.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	c	.004	.007	.010	0.10	0.18	0.25
Foot Angle	φ	0	4	8	0.00	101.60	203.20
Lead Width	B	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

\* Controlling Parameter

§ Significant Characteristic

### Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-150

Drawing No. C04-073

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## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>	<u>XXX</u>
Device	Temperature Range	Package	Pattern
Device	PIC17C756: Standard VDD range PIC17C756T: (Tape and Reel) PIC17LC756: Extended VDD range		
Temperature Range	-    =    0°C to +70°C I    =    -40°C to +85°C		
Package	CL   =   Windowed LCC PT   =   TQFP L    =   PLCC		
Pattern	QTP, SQTP, ROM Code (factory specified) or Special Requirements. Blank for OTP and Windowed devices.		

**Examples:**

- a) PIC17C756-16L Commercial Temp., PLCC package, 16 MHz, normal VDD limits
- b) PIC17LC756-08/PT Commercial Temp., TQFP package, 8MHz, extended VDD limits
- c) PIC17C756-33I/PT Industrial Temp., TQFP package, 33 MHz, normal VDD limits

\* JW Devices are UV erasable and can be programmed to any device configuration. JW Devices meet the electrical requirement of each oscillator type.

## Sales and Support

### Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Worldwide Site ([www.microchip.com](http://www.microchip.com))